HiQ-CBR Series, COG Dielectric, Low ESR 6.3 – 500 VDC, 1 MHz – 50 GHz (RF & Microwave)



Overview

KEMET's CBR Series surface mount multilayer ceramic capacitors (MLCCs) in C0G dielectric feature a robust and exceptionally stable copper electrode dielectric system that offers excellent low loss performance (high Q). These devices provide extremely low ESR and high self-resonance characteristics, and are well-suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required. CBR Series capacitors exhibit no change in capacitance with respect to time and voltage, and boast a negligible change in capacitance with

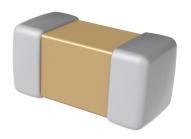


reference to ambient temperature. Capacitance change is limited to ±30 ppm/°C from -55°C to +125°C.

CBR Series devices are suitable for many circuit applications including RF power amplifiers, mixers, oscillators, low noise amplifiers, filter networks, antenna tuning, timing circuits, delay lines, and MRI imaging coils.

Benefits

- · High Q and low ESR
- · High SRF
- · High thermal stability
- 1 MHz to 50 GHz frequency range
- Operating temperature range of -55°C to +125°C
- Base metal electrode (BME) dielectric system
- · Pb-free and RoHS compliant
- 0201, 0402, 0603, and 0805 case sizes (inches)
- DC voltage ratings of 6.3 V, 10 V, 25 V, 50 V, 100 V, 200 V, 250 V, and 500 V
- · Capacitance offerings ranging from 0.1 pF up to 100 pF



Ordering Information

CBR	02	C	330	F	9	G	A	С	
Series	Case Size (L"x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Termination Style	Termination Finish	Packaging/ Grade (C-Spec) ¹
CBR	02 = 0201 04 = 0402 06 = 0603 08 = 0805	C = Standard	Two significant digits + number of zeros Use 9 for 1.0 - 9.9 pF Use 8 for 0.1 - 0.99 pF e.g., 2.2 pF = 229 e.g., 0.5 pF = 508	A = ±0.05 pF B = ±0.1 pF C = ±0.25 pF D = ±0.5 pF F = ±1% G = ±2% J = ±5%	9 = 6.3 V 8 = 10 V 3 = 25 V 5 = 50 V 1 = 100 V 2 = 200 V A = 250 V C = 500 V	G = COG	A = N/A	C = 100% Matte Sn	Blank = 7" Reel Unmarked

¹ When ordering CBR Series devices, a "suffix" or "C-Spec" is not required to indicate a 7" reel packaging option. CBR devices are only available and shipped on 7" reels (paper tape). Bulk bag and cassette packaging options are not available. Please contact KEMET if you have a specific, non-standard packaging requirement.



Benefits cont'd

- Available capacitance tolerances of ±0.05 pF, ±0.1 pF, ±0.25 pF, ±0.5 pF, ±1%, ±2%, and ±5%
- No piezoelectric noise
- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature
- · No capacitance decay with time
- Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability

Applications

Typical applications include critical timing, tuning, bypass, coupling, feedback, filtering, impedance matching and DC blocking.

Field applications include wireless and cellular base stations, wireless LAN, subscriber-based wireless services, wireless broadcast equipment, satellite communications, RF power amplifier (PA) modules, filters, voltage-controlled oscillators (VCOs), PAs, matching networks, RF modules, satellite communications and medical electronics.

Qualification

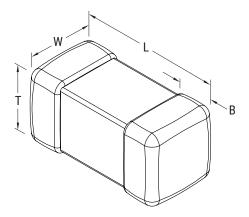
RF and microwave products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Environmental Compliance

Pb-free and RoHS compliant.



Dimensions - Millimeters (Inches)



Case Size (in.)	Case Size (mm)	L Length	W Width	T Thickness	B Bandwidth	Mounting Technique
0201	0603	0.60±0.03 (0.024±0.001)	0.30±0.03 (0.012±0.001)	0.30±0.03 (0.012±0.001)	0.15±0.05 (0.006±0.002)	Coldor Doflow Only
0402	1005	1.00±0.05 (0.040±0.002)	0.50±0.05 (0.020±0.002)	0.50±0.05 (0.020±0.002)	0.25+0.05/-0.10 (0.010+0.002/-0.004)	Solder Reflow Only
0603	1608	1.60±0.10 (0.063±0.004)	0.80±0.10 (0.031±0.004)	0.80±0.07 (0.031±0.003)	0.40±0.15 (0.016±0.006)	Solder Wave
0805	2012	2.00±0.20 (0.079±0.008)	1.25±0.20 (0.049±0.008)	0.85±0.10 (0.031±0.004)	0.50±0.20 (0.020±0.008)	or Solder Reflow

Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range:	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	0 ±30 ppm/°C (0 ±60 ppm/°C for 0201 case size product ≥ 22 pF)
Aging Rate (Maximum % Capacitance Loss/Decade Hour):	0%
¹ Dielectric Withstanding Voltage (DWV):	See Dielectric Withstanding Voltage Table (5±1 seconds and charge/discharge not exceeding 50 mA)
² Quality Factor (Q):	≥ 1,000 for capacitance values ≥ 30 pF ≥ 400 + 20°C for capacitance values < 30 pF
³ Insulation Resistance (IR) Limit at 25°C:	10 GΩ minimum (rated voltage applied for 120±5 seconds)

¹ DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 & Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

 $^{^2}$ Capacitance and quality factor (Q) measured at 1 MHz \pm 100 kHz and 1.0 \pm 0.2 Vrms.

³ To obtain IR limit, divide M Ω - μ F value by the capacitance and compare to G Ω limit. Select the lower of the two limits.

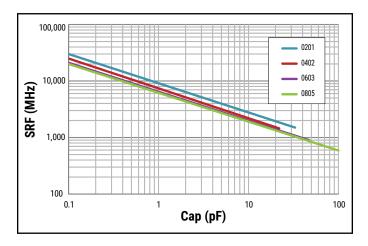


Dielectric Withstanding Voltage Table

Rated Voltage (VDC)	≤100 V	200 V	250 V	500 V
DWV	250%	200%	200%	150%

Electrical Characteristics

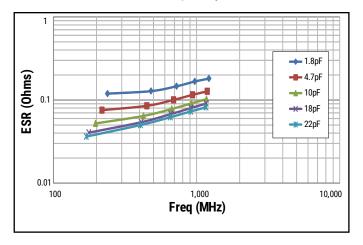
SRF (MHz) vs. Cap (pF)



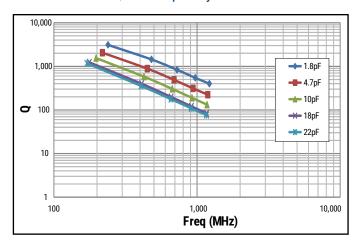


Electrical Characteristics cont'd

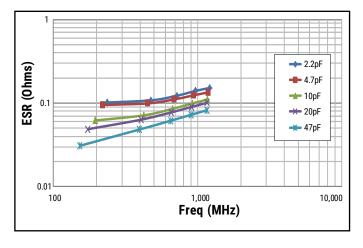
ESR vs. Frequency 0402



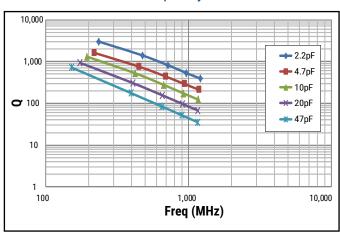
Q vs. Frequency 0402



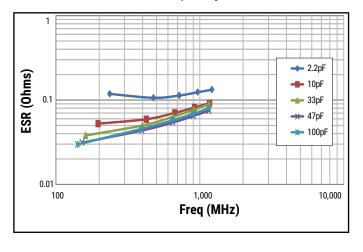
ESR vs. Frequency 0603



Q vs. Frequency 0603



ESR vs. Frequency 0805



Q vs. Frequency 0805

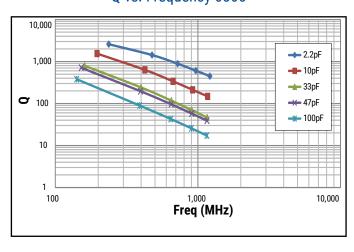




Table 1 - CBR Series, Capacitance Range Waterfall

Case Size -	Inches (mm)		0201	(0603)			0402	(1005)		06	03 (16	08)		0805	(2012)	
Length	mm (Inches)			± 0.03 ± 0.001)				± 0.05 ± 0.002)			1.60 ± 0.10 063 ± 0.0				± 0.20 ± 0.008)	
Width	mm (Inches)		0.30 ± 0.03 0.50 ± 0.05 (0.012 ± 0.001) (0.020 ± 0.002) 0.30 ± 0.03 0.50 ± 0.05 (0.012 ± 0.001) (0.020 ± 0.002)				0.80 ± 0.10 031 ± 0.00				± 0.20 ± 0.008)					
Thickness	mm (Inches)													0.80 ± 0.0 031 ± 0.0		
Bandwidth	mm (Inches)			± 0.05 ± 0.002)				.05 / -0.10 002 / -0.00	4)		0.40 ± 0.1 016 ± 0.0		0.50 ± 0.20 (0.020 ± 0.008)			
Rated Volt	age (VDC)	6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
Voltag	e Code	9	8	3	5	3	5	1	2	5	1	A	5	1	A	С
Capacitance	Capacitance Tolerance					Ca	pacitar	ice Cod	e (Avai	lable C	apacit	ance)				
0.1 pF	Toterance	108*	108*	108*	108*	108	108	108*	108*				1			
0.2 pF	A = ±0.05 pF	208	208	208	208	208	208	208	208							
0.3 pF	B = ±0.1 pF	308	308	308	308	308	308	308	308	308	308	308	308	308	308	308
0.4 pF 0.5 pF		408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508	408 508
0.5 pF		608	608	608	608	608	608	608	608	608	608	608	608	608	608	608
0.7 pF		708	708	708	708	708	708	708	708	708	708	708	708	708	708	708
0.8 pF		808	808	808	808	808	808	808	808	808	808	808	808	808	808	808
0.9 pF		908	908	908	908	908	908	908	908	908 109	908	908	908	908	908	908
1.0 pF 1.1 pF		109 119	109 119	109 119	109 119	109 119	109 119	109 119	119	119	109 119	109 119	109 119	109 119	109 119	109 119
1.2 pF		129	129	129	129	129	129	129	129	129	129	129	129	129	129	129
1.3 pF		139	139	139	139	139	139	139	139	139	139	139	139	139	139	139
1.4 pF		149	149	149	149	149	149	149	149	149	149	149	149	149	149	149
1.5 pF		159	159	159	159	159	159	159	159	159	159	159	159	159	159	159
1.6 pF 1.7 pF		169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179	169 179
1.7 pF		189	189	189	189	189	189	189	189	189	189	189	189	189	189	189
1.9 pF		199	199	199	199	199	199	199	199	199	199	199	199	199	199	199
2.0 pF		209	209	209	209	209	209	209	209	209	209	209	209	209	209	209
2.1 pF		219	219	219	219	219	219	219	219	219	219	219	219	219	219	219
2.2 pF 2.3 pF		229 239	229	229 239	229	229	229 239	229 239	229	229 239	229 239	229	229 239	229	229	229
2.4 pF		249	249	249	249	249	249	249	249	249	249	249	249	249	249	249
2.5 pF		259	259	259	259	259	259	259	259	259	259	259	259	259	259	259
2.6 pF	A = ±0.05 pF	269	269	269	269	269	269	269	269	269	269	269	269	269	269	269
2.7 pF	B = ±0.1 pF	279	279	279	279	279	279	279	279	279	279	279	279	279	279	279
2.8 pF	C = ±0.25 pF	289	289	289	289	289	289	289	289	289	289	289	289	289	289	289
2.9 pF 3.0 pF		299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309	299 309
3.0 pF		319	319	319	319	319	319	319	319	319	319	319	319	319	319	319
3.2 pF		329	329	329	329	329	329	329	329	329	329	329	329	329	329	329
3.3 pF		339	339	339	339	339	339	339	339	339	339	339	339	339	339	339
3.4 pF		349	349	349	349	349	349	349	349	349	349	349	349	349	349	349
3.5 pF 3.6 pF		359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369	359 369
3.0 pF 3.7 pF		379	379	379	379	379	379	379	379	379	379	379	379	379	379	379
3.8 pF		389	389	389	389	389	389	389	389	389	389	389	389	389	389	389
3.9 pF		399	399	399	399	399	399	399	399	399	399	399	399	399	399	399
4.0 pF		409	409	409	409	409	409	409	409	409	409	409	409	409	409	409
4.1 pF 4.2 pF		419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429	419 429
4.2 pr 4.3 pF		439	439	439	439	439	429	439	429	429	439	439	439	439	439	429
4.4 pF		449	449	449	449	449	449	449	449	449	449	449	449	449	449	449
4.5 pF		459	459	459	459	459	459	459	459	459	459	459	459	459	459	459
4.6 pF		469	469	469	469	469	469	469	469	469	469	469	469	469	469	469
4.7 pF		479	479	479	479	479	479 489	479	479 489	479 489	479 489	479 489	479	479	479 489	479 489
4.8 pF 4.9 pF		489 499	489 499	489 499	489 499	489 499	489	489 499	489	489	489	489	489 499	489 499	489	489
Rated Volt	tage (VDC)	6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
	e Code	9	8	3	5	3	5	1	2	5	1	A	5	1	A	C
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^{*}Available only in "B" ($\pm 0.1 pF$) capacitance tolerance.



Table 1 - CBR Series, Capacitance Range Waterfall cont'd

Case Size -	Inches (mm)		0201 ((0603)	<u> </u>		0402	(1005)		06	03 (16	N8)		0805	(2012)	
Length	mm			£ 0.03				± 0.05			1.60 ± 0.1				± 0.20	
	(Inches) mm			± 0.001)		(0.040 ± 0.002) 0.50 ± 0.05				063 ± 0.0 0.80 ± 0.1			_ •	± 0.008) ± 0.20		
Width	(Inches)		0.30 ± 0.03 (0.012 ± 0.001)			(0.020 ± 0.002)			(0.	031 ± 0.0	04)		(0.049 :	± 0.008)		
Thickness	mm (Inches)		0.30 ± 0.03 (0.012 ± 0.001)			0.50 ± 0.05 (0.020 ± 0.002)				0.80 ± 0.0 .031 ± 0.0				± 0.10 ± 0.004)		
Bandwidth	mm (Inches)		0.15 ±	0.05 ± 0.002)			0.25 + 0	.05 / -0.10 002 / -0.00	4)	,	0.40 ± 0.1 .016 ± 0.0	5		0.50	± 0.20 ± 0.008)	
Rated Volt		6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
Voltag	3 \ /	9	8	3	5	3	5	1	2	5	1	Α	5	1	Α	С
Capacitance	Capacitance Tolerance					Ca	pacitar	ice Cod	e (Avai	lable C	apacit	tance)				
	A = ±0.05 pF															
5.0 pF	B = ±0.1 pF C = ±0.25 pF	509	509	509	509	509	509	509	509	509	509	509	509	509	509	509
5.1 pF		519	519	519	519	519	519	519	519	519	519	519	519	519	519	519
5.2 pF 5.3 pF		529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539	529 539
5.4 pF		549	549	549	549	549	549	549	549	549	549	549	549	549	549	549
5.5 pF		559	559	559	559	559	559	559	559	559	559	559	559	559	559	559
5.6 pF		569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579	569 579
5.7 pF 5.8 pF		589	589	589	589	589	589	589	589	589	589	589	589	589	589	589
5.9 pF		599	599	599	599	599	599	599	599	599	599	599	599	599	599	599
6.0 pF		609	609	609	609	609	609	609	609	609	609	609	609	609	609	609
6.1 pF 6.2 pF		619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629	619 629
6.3 pF		639	639	639	639	639	639	639	639	639	639	639	639	639	639	639
6.4 pF		649	649	649	649	649	649	649	649	649	649	649	649	649	649	649
6.5 pF		659	659	659	659	659	659	659	659	659	659	659	659	659	659	659
6.6 pF 6.7 pF		669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679	669 679
6.8 pF		689	689	689	689	689	689	689	689	689	689	689	689	689	689	689
6.9 pF		699	699	699	699	699	699	699	699	699	699	699	699	699	699	699
7.0 pF		709	709	709	709	709	709	709	709	709	709	709	709	709	709	709
7.1 pF 7.2 pF	D 101 E	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729	719 729
7.2 pF 7.3 pF	B = ±0.1 pF C = ±0.25 pF	739	739	739	739	739	739	739	739	739	739	739	739	739	739	739
7.4 pF	D = ±0.5 pF	749	749	749	749	749	749	749	749	749	749	749	749	749	749	749
7.5 pF		759	759	759	759	759	759	759	759	759	759	759	759	759	759	759
7.6 pF		769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779	769 779
7.7 pF 7.8 pF		789	789	779	779	779	779	779	779	789	789	779	789	789	789	779
7.9 pF		799	799	799	799	799	799	799	799	799	799	799	799	799	799	799
8.0 pF		809	809	809	809	809	809	809	809	809	809	809	809	809	809	809
8.1 pF 8.2 pF		819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829	819 829
8.3 pF		839	839	839	839	839	839	839	839	839	839	839	839	839	839	839
8.4 pF		849	849	849	849	849	849	849	849	849	849	849	849	849	849	849
8.5 pF		859	859	859	859	859	859	859	859	859	859	859	859	859	859	859
8.6 pF		869 879	869 879	869 879	869 879	869 879	869 879	869	869 879	869 879	869 879	869 879	869 879	869 879	869 879	869 879
8.7 pF 8.8 pF		889	889	889	889	889	889	879 889	889	889	889	889	889	889	889	889
8.9 pF		899	899	899	899	899	899	899	899	899	899	899	899	899	899	899
9.0 pF		909	909	909	909	909	909	909	909	909	909	909	909	909	909	909
9.1 pF 9.2 pF		919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929	919 929
9.2 pF 9.3 pF		939	929	929	929	939	929	929	929	939	929	929	929	929	929	939
9.4 pF		949	949	949	949	949	949	949	949	949	949	949	949	949	949	949
9.5 pF		959	959	959	959	959	959	959	959	959	959	959	959	959	959	959
	tage (VDC)	6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
Voltag	e Code	9	8	3	5	3	5	1	2	5	1	A	5	1	A	С



Table 1 - CBR Series, Capacitance Range Waterfall cont'd

Case Size -	Inches (mm)		0201	(0603))		0402	(1005)		06	03 (16	08)		0805	(2012)	
Length	mm (Inches)			± 0.03 ± 0.001)			1.00 ± 0.05 (0.040 ± 0.002)			l .	1.60 ± 0.10 063 ± 0.0				± 0.20 ± 0.008)	
Width	mm (Inches)		0.30 ± 0.03 (0.012 ± 0.001)				(0.020	± 0.05 ± 0.002)		(0.	0.80 ± 0.10 031 ± 0.00	04)		(0.049	± 0.20 ± 0.008)	
Thickness	mm (Inches)		(0.012	± 0.03 ± 0.001)			(0.020	± 0.05) ± 0.002)		(0.	0.80 ± 0.0 031 ± 0.0	03)		(0.031	± 0.10 ± 0.004)	
Bandwidth	mm (Inches)		(0.006	± 0.05 ± 0.002)	1		(0.010 + 0.	0.05 / -0.10 002 / -0.00		(0.	0.40 ± 0.1 .016 ± 0.0	06)		(0.020	± 0.20 ± 0.008)	·
Rated Volt	tage (VDC)	6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
Voltag	e Code	9	8	3	5	3	5	1	2	5	1	A	5	1	Α	С
Capacitance	Capacitance Tolerance					Ca	pacitar	nce Cod	le (Avai	lable (apacit	ance)			,	,
9.6 pF		969	969	969	969	969	969	969	969	969	969	969	969	969	969	969
9.7 pF	B = ±0.1 pF C = ±0.25 pF	979	979	979	979	979	979	979	979	979	979	979	979	979	979	979
9.8 pF	D = ±0.5 pF	989	989	989	989	989	989	989	989	989	989	989	989	989	989	989
9.9 pF	В 20.0 рі	999	999	999	999	999	999	999	999	999	999	999	999	999	999	999
10 pF		100	100	100	100	100	100	100	100	100	100	100	100	100	100	100
11 pF		110	110	110	110	110	110	110	110	110	110	110	110	110	110	110
12 pF		120	120	120	120	120	120	120	120	120	120	120	120	120	120	120
13 pF		130	130	130	130	130	130	130	130	130	130	130	130	130	130	130
15 pF		150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150 160	150
16 pF 18 pF		180	180	180	180	180	180	180	180	180	180	180	180	180	180	160 180
20 pF		200	200	200	200	200	200	200	200	200	200	200	200	200	200	200
22 pF		220	220	220	200	220	220	220	220	220	220	220	220	220	220	220
24 pF		240	240	240		240	240	240	240	240	240	240	240	240	240	240
27 pF		270	270	270		270	270	270	270	270	270	270	270	270	270	270
30 pF	F = ±1%	300	300	300		300	300	300	300	300	300	300	300	300	300	300
33 pF	G = ±2%	330	330	330		330	330	330	330	330	330	330	330	330	330	330
36 pF	J = ±5%					360	360	360		360	360	360	360	360	360	360
39 pF						390	390	390		390	390	390	390	390	390	390
43 pF						430	430	430		430	430	430	430	430	430	430
47 pF						470	470	470		470	470	470	470	470	470	470
51 pF						510	510	510		510	510	510	510	510	510	510
56 pF						560	560	560		560	560	560	560	560	560	560
62 pF						620				620	620	620	620	620	620	620
68 pF						680				680	680	680	680	680	680	680
75 pF						750 820				750 820	750 820	750 820	750 820	750 820	750 820	
82 pF 91 pF						910				910	910	910	910	910	910	
100 pF						101				101	101	101	101	101	101	
Rated Volt	tage (VDC)	6.3	10	25	50	25	50	100	200	50	100	250	50	100	250	500
	e Code	9	8	3	5	3	5	1	2	5	1	A	5	1	Α	С



Table 2 - Chip Thickness/Reeling Quantities

Chip Size	Chip Thickness	Reel Q	uantity			
Inches (mm)	(mm)	7" Paper	13" Paper			
0201 (0603)	0.30 ±0.03	15,000				
0402 (1005)	0.50 ±0.05	10,000	Contact KEMET			
0603 (1608)	0.80 ±0.07	4,000	for availability.			
0805 (2012)	0.85 ±0.10	4,000				

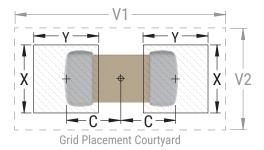
Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351 (mm)

Case Size (Inches)	Case Size (mm)	Density Level A: Maximum (Most) Land Protrusion					M	Density Level B: Median (Nominal) Land Protrusion				N	Density Level C: Minimum (Least) Land Protrusion				
(inches)	(11111)	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	X	V 1	V2	
0201	0603	0.38	0.56	0.52	1.80	1.00	0.33	0.46	0.42	1.50	0.80	0.28	0.36	0.32	1.20	0.60	
0402	1005	0.50	0.72	0.72	2.20	1.20	0.45	0.62	0.62	1.90	1.00	0.40	0.52	0.52	1.60	0.80	
0603	1608	0.90	1.15	1.10	4.00	2.10	0.80	0.95	1.00	3.10	1.50	0.60	0.75	0.90	2.40	1.20	
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70	

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of 0603(1608) and 0805 (2012) case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1608 case size.





Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for 0603 and 0805 case sizes
- 0201 and 0402 case sizes are limited to solder reflow only

Recommended Soldering Profile:

• KEMET recommends following the guidelines outlined in IPC/JEDEC J-STD-020

Recommended Solder Alloys:

Alloy	Composition	Solidus	Liquidous
In50	50 ln, 50 Pb	180°C	209°C
In52	52 ln, 48 Sn	118°C	118°C
Sn62	62.5 Sn, 36.1 Pb, 1.4 Ag	179°C	179°C
Sn63	63 Sn, 37 Pb	183°C	183°C
Pb-Free	95.5 Sn, 3.8 Ag, 0.7 Cu	217°C	217°C
Hi-Temp	5 Sn, 93.5 Pb, 1.5 Ag	296°C	301°C
Sn5	5 Sn, 95 Pb	308°C	312°C



Table 4 - Performance & Reliability: Test Methods & Conditions

Stress		Test or Inspection Me	thod	Requirements
Terminal Strength	02 04 08	izing force: 201 case size: 2N 402 & 0603 case sizes: 5N 805 case size: 10N 4: 10±1 second		No visible damage or separation of termination system.
Vibration Resistance	Total ar Test tim	on frequency: 10 ~ 55 Hz/minin nplitude: 1.5 mm ne: 6 hours (Two hours each in dicular directions.)		No visible damage. Cap change and Q/DF: To meet initial specification
Solderability		emperature: 235±5°C time: 2±0.5 seconds		95% minimum coverage of termination finish.
Board Flex	means of deflecting for 5±1	or is mounted to a substrate wor fram at a rate of 1 mm per se on becomes 1 mm. (Deflection second) room temperature for 24±2 hor gelectrical properties.	cond until the is maintained	No visible damage. Capacitance change: within ±5.0% or ±0.5 pF, whichever is larger. (Capacitance change is monitored during flexure.)
Resistance to Soldering Heat	Dipping Preheat the cap Store at	emperature: 260±5°C time: 10±1 second ing: 120 to 150°C for 1 minute acitor in a eutectic solder. room temperature for 24±2 hoing electrical properties.		No visible damage. Capacitance change: within ±2.5% or ±0.25 pF, whichever is larger. Q/DF, IR and dielectric strength: To meet initial requirements. 25% maximum leaching on each edge.
	5 cycles	s of steps 1 - 4:		
	Step	Temperature (°C)	Time (min.)	
	1	Minimum operating temperature +0/-3	30 ±3	No visible damage.
Temperature	2	Room temperature	2 ~ 3	Capacitance change: within ±2.5% or ±0.25 pF, whichever is larger.
Cycling	3	Maximum operating temperature +3/-0	30 ±3	Q/DF, IR and dielectric strength: To meet initial requirements.
	4	Room temperature (25°C)	2 ~ 3	
		room temperature for 24±2 ho	ours before	



Table 4 - Performance & Reliability: Test Methods & Conditions cont'd

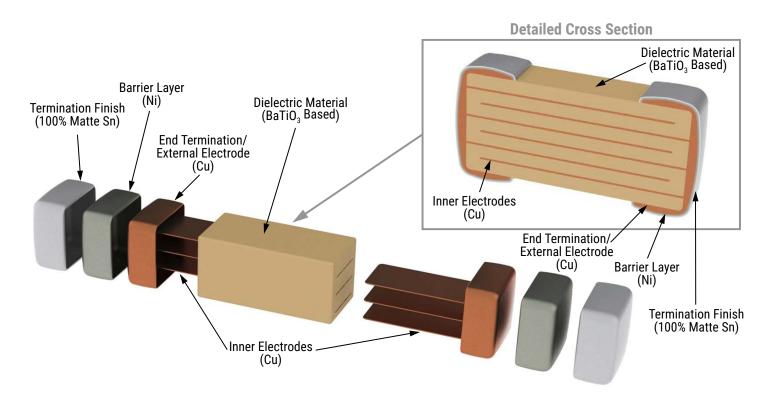
Stress	Test or Inspection Method	Requirements
Humidity (Damp Heat) Steady State	Test temperature: 40±2°C Humidity: 90 ~ 95% RH Test time: 500 +24/-0 hours Store at room temperature for 24±2 hours before measuring electrical properties.	No visible damage. Capacitance change: within $\pm 5.0\%$ or ± 0.5 pF, whichever is larger. Q/DF value: Capacitance ≥ 30 pF, Q ≥ 350 , $10 \text{ pF} \leq \text{Capacitance} < 30 \text{ pF}, \text{Q} \geq 275 + 2.5 ^{\circ}\text{C}$ Capacitance $< 10 \text{ pF}; \text{Q} \geq 200 + 10 ^{\circ}\text{C}$ IR: $\geq 16\Omega$
Humidity (Damp Heat) Load	Test temperature: 40±2°C Humidity: 90 ~ 95% RH Test time: 500 +24/-0 hours Applied voltage: rated voltage Store at room temperature for 24±2 hours before measuring electrical properties.	No visible damage. Capacitance change: within $\pm 7.5\%$ or ± 0.75 pF, whichever is larger. Q/DF value: Capacitance ≥ 30 pF, Q ≥ 200 , Capacitance < 30 pF, Q $\geq 100+10/3$ °C IR: $\geq 500 M\Omega$
High Temperature Life	Test temperature: 125±3°C Applied voltage: 200% of rated voltage (10 VDC - 250 VDC) 150% of rated voltage (6.3 VDC and 500 VDC) Test time: 1,000 +24/-0 hours Store at room temperature for 24±2 hours before measuring electrical properties.	No visible damage. Capacitance change: within $\pm 3.0\%$ or ± 0.3 pF, whichever is larger. Q/DF value: Capacitance ≥ 30 pF, Q ≥ 350 , $10 \text{ pF} \leq \text{Capacitance} < 30 \text{ pF}, \text{Q} \geq 275 \pm 2.5 ^{\circ}\text{C}$ Capacitance $< 10 \text{ pF}, \text{Q} \geq 200 \pm 10 ^{\circ}\text{C}$ IR: $\geq 1 \text{ G}\Omega$
		0201 Case Size 0402 Case Size 0.1 pF ≤ Capacitance ≤ 1 pF: 0.1 pF ≤ Capacitance ≤ 1 pF:
		$ \begin{array}{c c} < 350 \text{ m}\Omega/\text{pF} & < 350 \text{ m}\Omega/\text{pF} \\ \hline 1.0 \text{ pF} < \text{Capacitance} \leq 5.0 \text{ pF} \\ < 300 \text{ m}\Omega & < 300 \text{ m}\Omega \\ \hline \hline 5.0 \text{ pF} < \text{Capacitance} \leq 22.0 & 5.0 \text{ pF} < \text{Capacitance} \leq 100 \\ \hline \end{array} $
500	The ESR should be measured at room temperature and tested at frequency 1±0.1 GHz.	pF: < 250 mΩ pF: < 250 mΩ 0603 Case Size 0805 Case Size
ESR		0.3 pF ≤ Capacitance ≤ 1 pF: < 1,500 mΩ 0.3 pF ≤ Capacitance ≤ 1 pF: < 1,500 mΩ
		1 pF < Capacitance ≤ 10 pF: 1 pF < Capacitance ≤ 10 pF: < 250 m Ω < 250 m Ω
		10 pF < Capacitance ≤ 100 pF: Capacitance > 10 pF: < 200 mΩ < 200 mΩ
	The ESR should be measured at room temperature and tested at frequency 500±50 MHz.	0201 case size, 22pF ≤ Cap ≤ 33pF: < 300 mΩ



Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.

Construction



Marking

CBR series devices are supplied unmarked.

If you require marked product, please contact KEMET for availability of a laser-marked option.



Tape & Reel Packaging Information

KEMET offers RF and Microwave Multilayer Ceramic Chip Capacitors packaged in 8 mm tape on 7" reels. This packaging system is compatible with all tape-fed automatic pick and place systems.

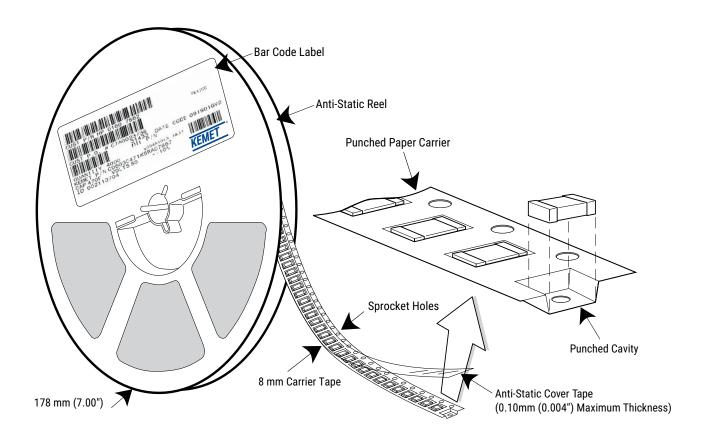


Table 5 - Carrier Tape Configuration (mm)

EIA Case Size	Tape Size (W)*	Lead Space (P ₁)*
0201 - 0402	8	2
0603 - 1210	8	4

^{*}Refer to Figure 1 for W and P_1 carrier tape reference locations.

^{*}Refer to Table 6 for tolerance specifications.



Figure 1 - Punched (Paper) Carrier Tape Dimensions

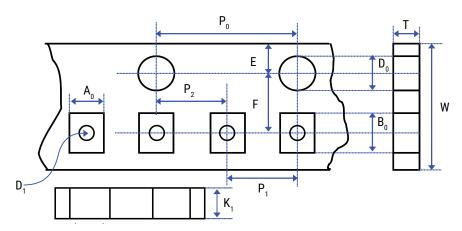


Table 6 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)							
Tape Size	D_0	E ₁	P ₀	P ₂	R Reference Note 2	K_0		
8 mm	1.55+0.05 (0.061+0.002)	1.55±0.05 (0.061±0.002)	4.0±0.10 (0.157±0.004)	2.0±0.05 (0.079±0.002)	25.0 (0.984)	-		
Variable Dimensions — Millimeters (Inches)								
Tape Size	Pitch	A_0	B ₀	F	P ₁	T	W	D_1
8 mm Half (2 mm)	0.37±0.03 (0.015±0.001)	0.67±0.03 (0.03±0.001)	2.0±0.05 (0.079±0.002) 3.5±0.05	2.0±0.05	0.42±0.03 (0.017±0.001)			
	0.62±0.05 (0.025±0.002)	1.12±0.05 (0.04±0.002)		0.60±0.05 (0.024±0.002)	8.0±0.10			
8 mm Single (4 mm)	1.00±0.10 (0.040±0.004)	1.80±0.10 (0.07±0.004)	(0.138±0.002)	02) 4.0±0.10 (0.157±0.004)	0.95±0.05 (0.037±0.002)	(0.315±0.004)	-	
	1.50±0.10 (0.06±0.004)	2.30±0.10 (0.09±0.004)			0.95±0.05 (0.037±0.002)			

^{2.} The tape with or without components shall pass around R without damage (see Figure 3).



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength	
8 mm	0.1 to 1.0 Newton (10 to 100 gf)	
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)	

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

Figure 2 - Bending Radius

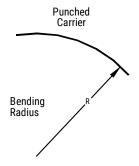


Figure 3 - Tape Leader & Trailer Dimensions

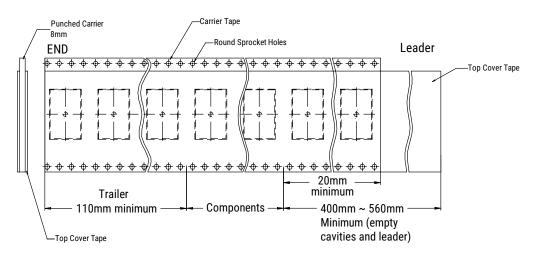




Figure 4 - Maximum Camber

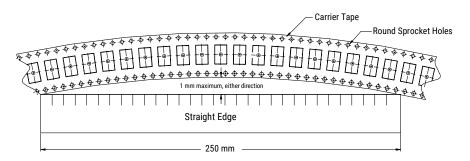


Figure 5 - Reel Dimensions

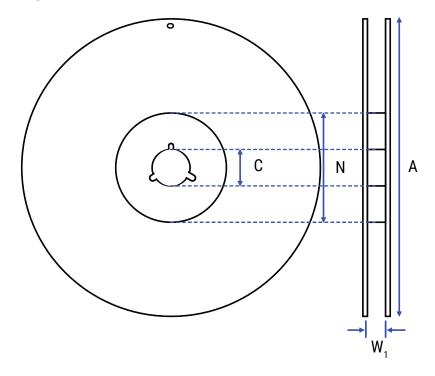


Table 7 - Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)						
Tape Size	Reel Size	Α	С			
8 mm	7	178±0.10 (7.008±0.004)	13.0±0.20 (0.512±0.008)			
Variable Dimensions — Millimeters (Inches)						
Tape Size	N Minimum See Note 2, Table 6	W ₁				
8 mm	60±0.10 (2.4±0.04)	8.4+1.5/-0.0 (0.331+0.059/-0.0)				



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